

ExaMAX®





(2.00 mm) .0787"

ExaMAX® BACKPLANE SYSTEM

Provides 2.00 mm exceptionally Mates with: **SPECIFICATIONS** column pitch low mating FBTF-RA For complete specifications and recommended PCB layouts see www.samtec.com?EBTM-VT or force while PAM4 maintaining excellent www.samtec.com?EBTM-RA normal force Insulator Material: Liquid Crystal Polymer Contact Material: Copper Alloy Copper Alloy Plating: Sn or Au over 50 µ" (1.27 µm) Ni Operating Temp Range: -55 °C to +85 °C Current Rating: **APPLICATION** 4.2 A per pin (1 pin powered) Contact Wipe: 2.4 mm RoHS Compliant: Two reliable **RECOGNITIONS** points of contact Press-fit with 2.4 mm wipe For complete scope termination of recognitions see www.samtec.com/quality NO. OF PAIRS COLUMN EBTM **COLUMNS** PER COLUMN **PITCH**

ALSO AVAILABLE (MOQ Required)

· Staging

GUIDANCE (EBTM-VT)

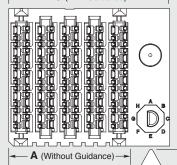
-L /-R

TOOLING

· For press-fit extraction and insertion tool options, visit www.samtec.com/tooling

> -A -B -C -D -E

_4 = 4 Pairs
-6 = 6 Pairs
C (With Guidance)



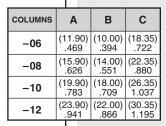
-06

-08**-10** -12 (-6 pairs only)



-2.0= (2.0 mm) .0787"

	NO. OF PAIRS PER COLUMN	D	E
	-4	(22.50) .886	(15.60) .614
	-6	(29.70) 1.169	(22.80) .898



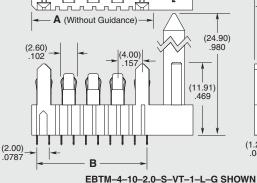
KEYING

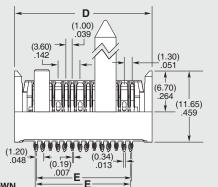
-F

-G -H

Some lengths, styles and options are non-standard, non-returnable.

ExaMAX® is a registered trademark of AFCI.





Due to technical progress, all designs, specifications and components are subject to change without notice

